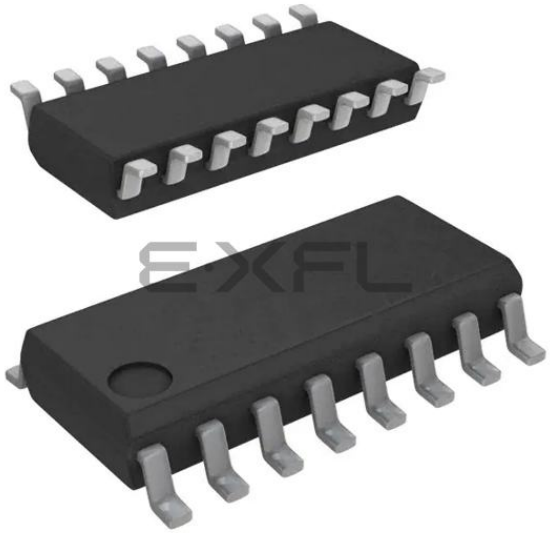

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Details	
Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	Cap Sense, POR, PWM, WDT
Number of I/O	13
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-SOIC (0.154", 3.90mm Width)
Supplier Device Package	16-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f834-gsr

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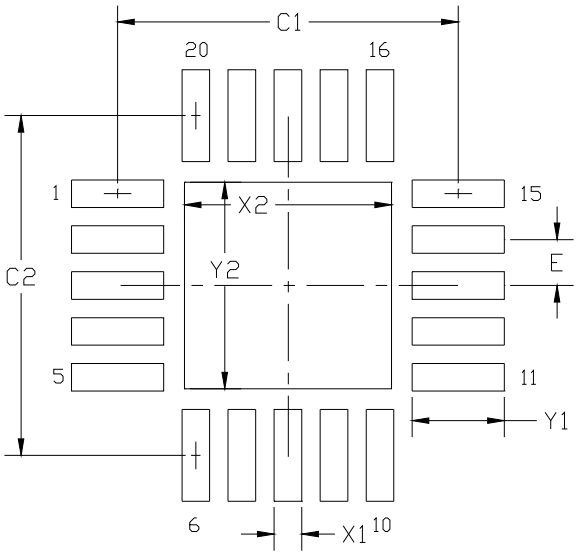

Figure 4.2. QFN-20 Recommended PCB Land Pattern

Table 4.2. QFN-20 PCB Land Pattern Dimensions

Dimension	Min	Max
C1	3.70	
C2	3.70	
E	0.50	
X1	0.20	0.30

Dimension	Min	Max
X2	2.15	2.25
Y1	0.90	1.00
Y2	2.15	2.25

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
3. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
6. The stencil thickness should be 0.125 mm (5 mils).
7. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pins.
8. A 2x2 array of 0.95 mm openings on a 1.1 mm pitch should be used for the center pad to assure the proper paste volume.

Card Assembly

9. A No-Clean, Type-3 solder paste is recommended.
10. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

Table 7.9. ADC0 Electrical Characteristics

V_{DD} = 3.0 V, VREF = 2.40 V (REFSL=0), –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution			10		bits
Integral Nonlinearity		—	±0.5	±1	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	±0.5	±1	LSB
Offset Error		–2	0	2	LSB
Full Scale Error		–2	0	2	LSB
Offset Temperature Coefficient		—	45	—	ppm/°C
Dynamic performance (10 kHz sine-wave single-ended input, 1 dB below Full Scale, 200 ksps)					
Signal-to-Noise Plus Distortion		54	60	—	dB
Total Harmonic Distortion	Up to the 5th harmonic	—	75	—	dB
Spurious-Free Dynamic Range		—	–90	—	dB
Conversion Rate					
SAR Conversion Clock		—	—	8.33	MHz
Conversion Time in SAR Clocks	10-bit Mode 8-bit Mode	13 11	— —	— —	clocks clocks
Track/Hold Acquisition Time	V_{DD} >= 2.0 V V_{DD} < 2.0 V	300 2.0	— —	— —	ns µs
Throughput Rate		—	—	500	ksps
Analog Inputs					
ADC Input Voltage Range		0	—	VREF	V
Sampling Capacitance	1x Gain 0.5x Gain	— —	5 3	— —	pF pF
Input Multiplexer Impedance		—	5	—	kΩ
Power Specifications					
Power Supply Current	Operating Mode, 500 ksps	—	630	1000	µA
Power Supply Rejection		—	–70	—	dB

Table 7.10. Power Management Electrical Characteristics

V_{DD} = 1.8 to 3.6 V; T_A = –40 to +85 °C unless otherwise specified. Use factory-calibrated settings.

Parameter	Conditions	Min	Typ	Max	Units
Idle Mode Wake-Up Time		2	—	3	SYSCLKs
Suspend Mode Wake-up Time		—	500	—	ns

Table 7.11. Temperature Sensor Electrical Characteristics

V_{DD} = 3.0 V, –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Linearity		—	1	—	°C
Slope		—	2.43	—	mV/°C
Slope Error*		—	±45	—	µV/°C
Offset	Temp = 0 °C	—	873	—	mV
Offset Error*	Temp = 0 °C	—	14.5	—	mV
***Note:** Represents one standard deviation from the mean.					

Table 7.12. Voltage Reference Electrical Characteristics

V_{DD} = 1.8 to 3.6 V; –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Internal High Speed Reference (REFSL[1:0] = 11)					
Output Voltage	25 °C ambient	1.55	1.65	1.75	V
Turn-on Time		—	—	1.7	µs
Supply Current		—	180	—	µA
External Reference (REF0E = 0)					
Input Voltage Range		0	—	V_{DD}	
Input Current	Sample Rate = 500 ksps; VREF = 3.0 V	—	7	—	µA

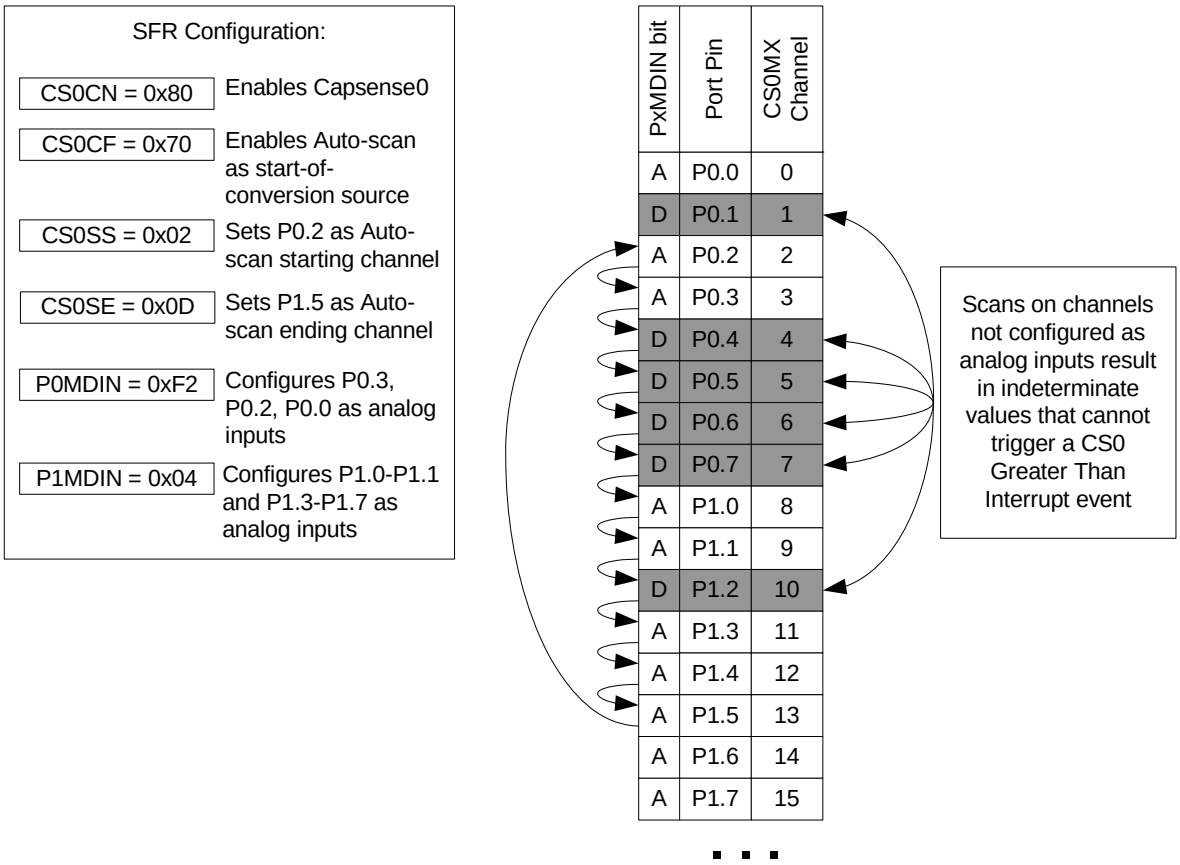

Figure 13.2. Auto-Scan Example

13.4. CS0 Comparator

The CS0 comparator compares the latest capacitive sense conversion result with the value stored in CS0THH:CS0THL. If the result is less than or equal to the stored value, the CS0CMPF bit(CS0CN:0) is set to 0. If the result is greater than the stored value, CS0CMPF is set to 1.

If the CS0 conversion accumulator is configured to accumulate multiple conversions, a comparison will not be made until the last conversion has been accumulated.

An interrupt will be generated if CS0 greater-than comparator interrupts are enabled by setting the ECSGRT bit (EIE2.1) when the comparator sets CS0CMPF to 1.

If auto-scan is running when the comparator sets the CS0CMPF bit, no further auto-scan initiated conversions will start until firmware sets CS0BUSY to 1.

A CS0 greater-than comparator event can wake a device from suspend mode. This feature is useful in systems configured to continuously sample one or more capacitive sense channels. The device will remain in the low-power suspend state until the captured value of one of the scanned channels causes a CS0 greater-than comparator event to occur. It is not necessary to have CS0 comparator interrupts enabled in order to wake a device from suspend with a greater-than event.

Note: On waking from suspend mode due to a CS0 greater-than comparator event, the CS0CN register should be accessed only after at least two system clock cycles have elapsed.

For a summary of behavior with different CS0 comparator, auto-scan, and auto accumulator settings, please see Table 13.1.

Table 17.2. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
SBUF0	0x99	UART0 Data Buffer	207
SCON0	0x98	UART0 Control	206
SMB0ADM	0xD6	SMBus Slave Address mask	191
SMB0ADR	0xD7	SMBus Slave Address	191
SMB0CF	0xC1	SMBus Configuration	186
SMB0CN	0xC0	SMBus Control	188
SMB0DAT	0xC2	SMBus Data	192
SP	0x81	Stack Pointer	89
SPI0CFG	0xA1	SPI0 Configuration	174
SPI0CKR	0xA2	SPI0 Clock Rate Control	176
SPI0CN	0xF8	SPI0 Control	175
SPI0DAT	0xA3	SPI0 Data	176
TCON	0x88	Timer/Counter Control	215
TH0	0x8C	Timer/Counter 0 High	218
TH1	0x8D	Timer/Counter 1 High	218
TL0	0x8A	Timer/Counter 0 Low	217
TL1	0x8B	Timer/Counter 1 Low	217
TMOD	0x89	Timer/Counter Mode	216
TMR2CN	0xC8	Timer/Counter 2 Control	222
TMR2H	0xCD	Timer/Counter 2 High	224
TMR2L	0xCC	Timer/Counter 2 Low	224
TMR2RLH	0xCB	Timer/Counter 2 Reload High	223
TMR2RLL	0xCA	Timer/Counter 2 Reload Low	223
VDM0CN	0xFF	VDD Monitor Control	126
XBR0	0xE1	Port I/O Crossbar Control 0	148
XBR1	0xE2	Port I/O Crossbar Control 1	149
All other SFR Locations		Reserved	

18.3. $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ External Interrupts

The $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ external interrupt sources are configurable as active high or low, edge or level sensitive. The IN0PL ($\overline{\text{INT0}}$ Polarity) and IN1PL ($\overline{\text{INT1}}$ Polarity) bits in the IT01CF register select active high or active low; the IT0 and IT1 bits in TCON (Section “28.1. Timer 0 and Timer 1” on page 211) select level or edge sensitive. The table below lists the possible configurations.

IT0	IN0PL	$\overline{\text{INT0}}$ Interrupt
1	0	Active low, edge sensitive
1	1	Active high, edge sensitive
0	0	Active low, level sensitive
0	1	Active high, level sensitive

IT1	IN1PL	$\overline{\text{INT1}}$ Interrupt
1	0	Active low, edge sensitive
1	1	Active high, edge sensitive
0	0	Active low, level sensitive
0	1	Active high, level sensitive

$\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ are assigned to Port pins as defined in the IT01CF register (see SFR Definition 18.7). Note that $\overline{\text{INT0}}$ and $\overline{\text{INT0}}$ Port pin assignments are independent of any Crossbar assignments. $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ will monitor their assigned Port pins without disturbing the peripheral that was assigned the Port pin via the Crossbar. To assign a Port pin only to $\overline{\text{INT0}}$ and/or $\overline{\text{INT1}}$, configure the Crossbar to skip the selected pin(s). This is accomplished by setting the associated bit in register XBR0 (see Section “23.3. Priority Crossbar Decoder” on page 143 for complete details on configuring the Crossbar).

IE0 (TCON.1) and IE1 (TCON.3) serve as the interrupt-pending flags for the $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ external interrupts, respectively. If an $\overline{\text{INT0}}$ or $\overline{\text{INT1}}$ external interrupt is configured as edge-sensitive, the corresponding interrupt-pending flag is automatically cleared by the hardware when the CPU vectors to the ISR. When configured as level sensitive, the interrupt-pending flag remains logic 1 while the input is active as defined by the corresponding polarity bit (IN0PL or IN1PL); the flag remains logic 0 while the input is inactive. The external interrupt source must hold the input active until the interrupt request is recognized. It must then deactivate the interrupt request before execution of the ISR completes or another interrupt request will be generated.

21. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled.

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pullups are enabled during and after the reset. For V_{DD} Monitor and power-on resets, the $\overline{RST}$ pin is driven low until the device exits the reset state.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to the internal oscillator. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source. Program execution begins at location 0x0000.

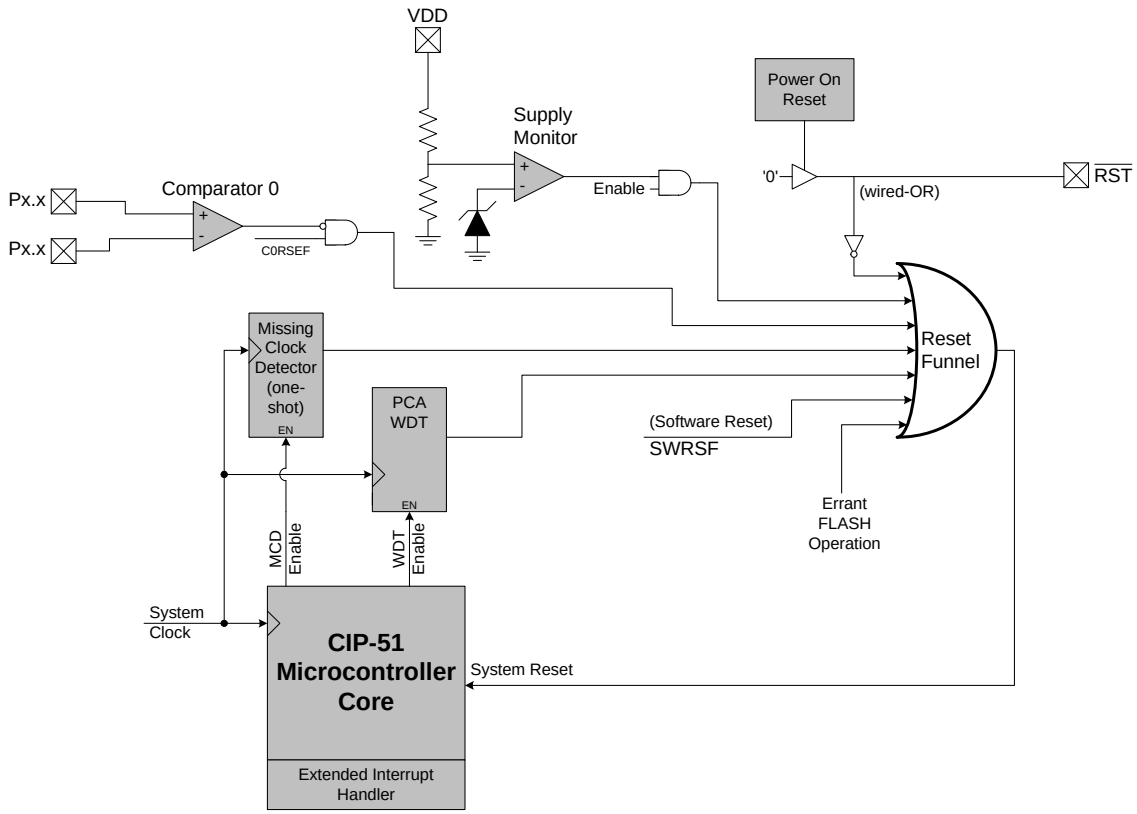

Figure 21.1. Reset Sources

SFR Definition 21.1. VDM0CN: V_{DD} Monitor Control

Bit	7	6	5	4	3	2	1	0
Name	VDMEN	VDDSTAT						
Type	R/W	R	R	R	R	R	R	R
Reset	Varies	Varies	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0xFF

Bit	Name	Function
7	VDMEN	**V_{DD} Monitor Enable.** This bit turns the V_{DD} monitor circuit on/off. The V_{DD} Monitor cannot generate system resets until it is also selected as a reset source in register RSTSRC (SFR Definition 21.2). Selecting the V_{DD} monitor as a reset source before it has stabilized may generate a system reset. In systems where this reset would be undesirable, a delay should be introduced between enabling the V_{DD} Monitor and selecting it as a reset source. After a power-on reset, the VDD monitor is enabled, and this bit will read 1. The state of this bit is sticky through any other reset source. 0: V_{DD} Monitor Disabled. 1: V_{DD} Monitor Enabled.
6	VDDSTAT	**V_{DD} Status.** This bit indicates the current power supply status (V_{DD} Monitor output). 0: V_{DD} is at or below the V_{DD} monitor threshold. 1: V_{DD} is above the V_{DD} monitor threshold.
5:0	Unused	Read = Varies; Write = Don't care.

21.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pullup and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See Section "7. Electrical Characteristics" on page 39 for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

21.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If the system clock remains high or low for more than the MCD timeout, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read 1, signifying the MCD as the reset source; otherwise, this bit reads 0. Writing a 1 to the MCDRSF bit enables the Missing Clock Detector; writing a 0 disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

SFR Definition 21.2. RSTSRC: Reset Source

Bit	7	6	5	4	3	2	1	0
Name		FERROR	C0RSEF	SWRSF	WDTRSF	MCDRSF	PORSF	PINRSF
Type	R	R	R/W	R/W	R	R/W	R/W	R
Reset	0	Varies	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0xEF

Bit	Name	Description	Write	Read
7	Unused	**Unused.**	Don't care.	0
6	FERROR	**Flash Error Reset Flag.**	N/A	Set to 1 if Flash read/write/erase error caused the last reset.
5	C0RSEF	**Comparator0 Reset Enable and Flag.**	Writing a 1 enables Comparator0 as a reset source (active-low).	Set to 1 if Comparator0 caused the last reset.
4	SWRSF	**Software Reset Force and Flag.**	Writing a 1 forces a system reset.	Set to 1 if last reset was caused by a write to SWRSF.
3	WDTRSF	**Watchdog Timer Reset Flag.**	N/A	Set to 1 if Watchdog Timer overflow caused the last reset.
2	MCDRSF	**Missing Clock Detector Enable and Flag.**	Writing a 1 enables the Missing Clock Detector. The MCD triggers a reset if a missing clock condition is detected.	Set to 1 if Missing Clock Detector timeout caused the last reset.
1	PORSF	**Power-On / V_{DD} Monitor Reset Flag, and V_{DD} monitor Reset Enable.**	Writing a 1 enables the V_{DD} monitor as a reset source. **Writing 1 to this bit before the V_{DD} monitor is enabled and stabilized may cause a system reset.**	Set to 1 anytime a power-on or V_{DD} monitor reset occurs. **When set to 1 all other RSTSRC flags are indeterminate.**
0	PINRSF	**HW Pin Reset Flag.**	N/A	Set to 1 if $\overline{\text{RST}}$ pin caused the last reset.

Note: Do not use read-modify-write operations on this register

22.2. Programmable Internal High-Frequency (H-F) Oscillator

All C8051F80x-83x devices include a programmable internal high-frequency oscillator that defaults as the system clock after a system reset. The internal oscillator period can be adjusted via the OSCICL register as defined by SFR Definition 22.2.

On C8051F80x-83x devices, OSCICL is factory calibrated to obtain a 24.5 MHz base frequency.

The internal oscillator output frequency may be divided by 1, 2, 4, or 8, as defined by the IFCN bits in register OSCICN. The divide value defaults to 8 following a reset.

The precision oscillator supports a spread spectrum mode which modulates the output frequency in order to reduce the EMI generated by the system. When enabled (SSE = 1), the oscillator output frequency is modulated by a stepped triangle wave whose frequency is equal to the oscillator frequency divided by 384 (63.8 kHz using the factory calibration). The maximum deviation from the center frequency is ±0.75%. The output frequency updates occur every 32 cycles and the step size is typically 0.25% of the center frequency.

SFR Definition 22.2. OSCICL: Internal H-F Oscillator Calibration

Bit	7	6	5	4	3	2	1	0
Name	OSCICL[6:0]							
Type	R/W							
Reset	Varies	Varies	Varies	Varies	Varies	Varies	Varies	Varies

SFR Address = 0xB3

Bit	Name	Function
6:0	OSCICL[7:0]	**Internal Oscillator Calibration Bits.** These bits determine the internal oscillator period. When set to 00000000b, the H-F oscillator operates at its fastest setting. When set to 11111111b, the H-F oscillator operates at its slowest setting. The reset value is factory calibrated to generate an internal oscillator frequency of 24.5 MHz.

Port	P0								P1								P2
Pin Number	0	1	2	3	4	5	6	7	0	1	2	3	4[1]	5[1]	6[1]	7[1]	0
Special Function Signals	VREF	AGND	XTAL1	XTAL2			CNVSTR										Signal Unavailable to Crossbar
TX0					■												
RX0						■											
SCK	■																
MISO		■															
MOSI			■														
NSS[2]				■													
SDA																	
SCL																	
CP0																	
CP0A																	
SYSCLK																	
CEX0							■										
CEX1								■									
CEX2									■								
ECI																	
T0																	
T1																	
Pin Skip Settings	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	P0SKIP								P1SKIP								

In this example, the crossbar is configured to assign the UART TX0 and RX0 signals, the SPI signals, and the PCA signals. Note that the SPI signals are assigned as multiple signals, and there are no pins skipped using the P0SKIP or P1SKIP registers.

■ These boxes represent the port pins which are used by the peripherals in this configuration.

1st TX0 is assigned to P0.4
2nd RX0 is assigned to P0.5
3rd SCK, MISO, MOSI, and NSS are assigned to P0.0, P0.1, P0.2, and P0.3, respectively.
4th CEX0, CEX1, and CEX2 are assigned to P0.6, P0.7, and P1.0, respectively.

All unassigned pins can be used as GPIO or for other non-crossbar functions.

Notes:
1. P1.4-P1.7 are not available on 16-pin packages.
2. NSS is only pinned out when the SPI is in 4-wire mode.

Figure 23.5. Priority Crossbar Decoder Example 1—No Skipped Pins

SFR Definition 23.2. XBR1: Port I/O Crossbar Register 1

Bit	7	6	5	4	3	2	1	0
Name	WEAKPUD	XBARE	T1E	T0E	ECIE		PCA0ME[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE2

Bit	Name	Function
7	WEAKPUD	**Port I/O Weak Pullup Disable.** 0: Weak Pullups enabled (except for Ports whose I/O are configured for analog mode). 1: Weak Pullups disabled.
6	XBARE	**Crossbar Enable.** 0: Crossbar disabled. 1: Crossbar enabled.
5	T1E	**T1 Enable.** 0: T1 unavailable at Port pin. 1: T1 routed to Port pin.
4	T0E	**T0 Enable.** 0: T0 unavailable at Port pin. 1: T0 routed to Port pin.
3	ECIE	**PCA0 External Counter Input Enable.** 0: ECI unavailable at Port pin. 1: ECI routed to Port pin.
2	Unused	Read = 0b; Write = Don't Care.
1:0	PCA0ME[1:0]	**PCA Module I/O Enable Bits.** 00: All PCA I/O unavailable at Port pins. 01: CEX0 routed to Port pin. 10: CEX0, CEX1 routed to Port pins. 11: CEX0, CEX1, CEX2 routed to Port pins.

SFR Definition 23.10. P0SKIP: Port 0 Skip

Bit	7	6	5	4	3	2	1	0
Name	P0SKIP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD4

Bit	Name	Function
7:0	P0SKIP[7:0]	**Port 0 Crossbar Skip Enable Bits.** These bits select Port 0 pins to be skipped by the Crossbar Decoder. Port pins used for analog, special functions or GPIO should be skipped by the Crossbar. 0: Corresponding P0.n pin is not skipped by the Crossbar. 1: Corresponding P0.n pin is skipped by the Crossbar.

SFR Definition 23.11. P1: Port 1

Bit	7	6	5	4	3	2	1	0
Name	P1[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0x90; Bit-Addressable

Bit	Name	Description	Write	Read
7:0	P1[7:0]	**Port 1 Data.** Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O. **Note:** P1.4–P1.7 are not available on 16-pin packages.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P1.n Port pin is logic LOW. 1: P1.n Port pin is logic HIGH.

26.5.2. Read Sequence (Master)

During a read sequence, an SMBus master reads data from a slave device. The master in this transfer will be a transmitter during the address byte, and a receiver during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 1 (READ). Serial data is then received from the slave on SDA while the SMBus outputs the serial clock. The slave transmits one or more bytes of serial data.

If hardware ACK generation is disabled, the ACKRQ is set to 1 and an interrupt is generated after each received byte. Software must write the ACK bit at that time to ACK or NACK the received byte.

With hardware ACK generation enabled, the SMBus hardware will automatically generate the ACK/NACK, and then post the interrupt. **It is important to note that the appropriate ACK or NACK value should be set up by the software prior to receiving the byte when hardware ACK generation is enabled.**

Writing a 1 to the ACK bit generates an ACK; writing a 0 generates a NACK. Software should write a 0 to the ACK bit for the last data transfer, to transmit a NACK. The interface exits Master Receiver Mode after the STO bit is set and a STOP is generated. The interface will switch to Master Transmitter Mode if SMB0DAT is written while an active Master Receiver. Figure 26.6 shows a typical master read sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur at different places in the sequence, depending on whether hardware ACK generation is enabled. The interrupt occurs **before** the ACK with hardware ACK generation disabled, and **after** the ACK when hardware ACK generation is enabled.

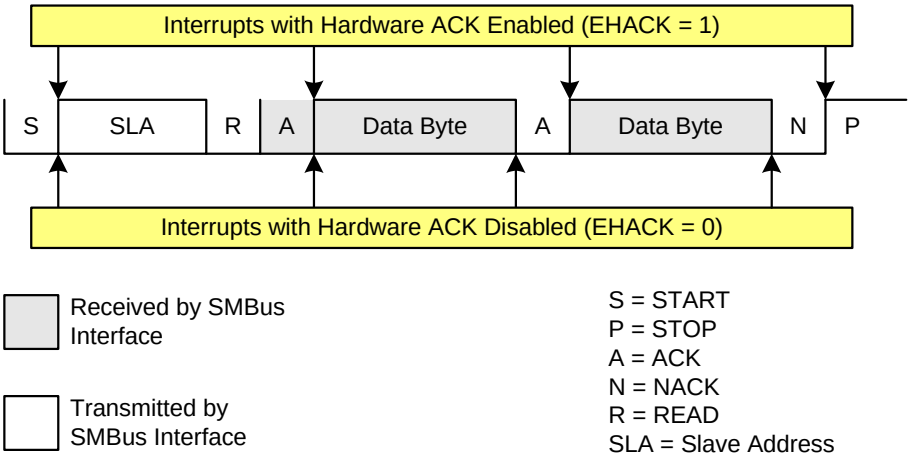

Figure 26.6. Typical Master Read Sequence

27.1. Enhanced Baud Rate Generation

The UART0 baud rate is generated by Timer 1 in 8-bit auto-reload mode. The TX clock is generated by TL1; the RX clock is generated by a copy of TL1 (shown as RX Timer in Figure 27.2), which is not user-accessible. Both TX and RX Timer overflows are divided by two to generate the TX and RX baud rates. The RX Timer runs when Timer 1 is enabled, and uses the same reload value (TH1). However, an RX Timer reload is forced when a START condition is detected on the RX pin. This allows a receive to begin any time a START is detected, independent of the TX Timer state.

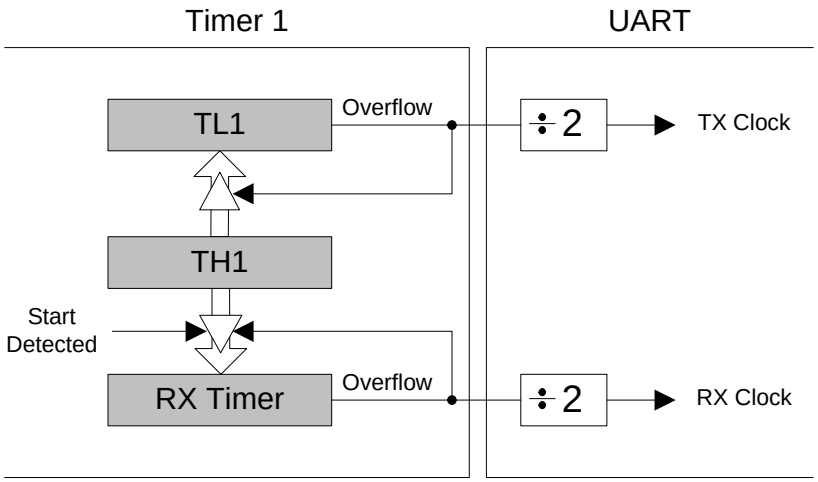

Figure 27.2. UART0 Baud Rate Logic

Timer 1 should be configured for Mode 2, 8-bit auto-reload (see Section "28.1.3. Mode 2: 8-bit Counter/Timer with Auto-Reload" on page 212). The Timer 1 reload value should be set so that overflows will occur at two times the desired UART baud rate frequency. Note that Timer 1 may be clocked by one of six sources: SYSCLK, SYSCLK/4, SYSCLK/12, SYSCLK/48, the external oscillator clock/8, or an external input T1. For any given Timer 1 clock source, the UART0 baud rate is determined by Equation 27.1-A and Equation 27.1-B.

A) $$\text{UartBaudRate} = \frac{1}{2} \times \text{T1\_Overflow\_Rate}$$

B) $$\text{T1\_Overflow\_Rate} = \frac{\text{T1}_{\text{CLK}}}{256 - \text{TH1}}$$

Equation 27.1. UART0 Baud Rate

Where $T1_{CLK}$ is the frequency of the clock supplied to Timer 1, and *T1H* is the high byte of Timer 1 (reload value). Timer 1 clock frequency is selected as described in Section "28. Timers" on page 209. A quick reference for typical baud rates and system clock frequencies is given in Table 27.1 through Table 27.2. The internal oscillator may still generate the system clock when the external oscillator is driving Timer 1.

SFR Definition 28.4. TL0: Timer 0 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TL0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8A

Bit	Name	Function
7:0	TL0[7:0]	**Timer 0 Low Byte.** The TL0 register is the low byte of the 16-bit Timer 0.

SFR Definition 28.5. TL1: Timer 1 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TL1[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8B

Bit	Name	Function
7:0	TL1[7:0]	**Timer 1 Low Byte.** The TL1 register is the low byte of the 16-bit Timer 1.

SFR Definition 28.11. TMR2L: Timer 2 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCC

Bit	Name	Function
7:0	TMR2L[7:0]	**Timer 2 Low Byte.** In 16-bit mode, the TMR2L register contains the low byte of the 16-bit Timer 2. In 8-bit mode, TMR2L contains the 8-bit low byte timer value.

SFR Definition 28.12. TMR2H Timer 2 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCD

Bit	Name	Function
7:0	TMR2H[7:0]	**Timer 2 Low Byte.** In 16-bit mode, the TMR2H register contains the high byte of the 16-bit Timer 2. In 8-bit mode, TMR2H contains the 8-bit high byte timer value.